Single Supply Dual Operational Amplifiers

Utilizing the circuit designs perfected for Quad Operational Amplifiers, these dual operational amplifiers feature low power drain, a common mode input voltage range extending to ground/V_{EE}, and single supply or split supply operation. The LM358 series is equivalent to one-half of an LM324.

These amplifiers have several distinct advantages over standard operational amplifier types in single supply applications. They can operate at supply voltages as low as 3.0 V or as high as 32 V, with quiescent currents about one-fifth of those associated with the MC1741 (on a per amplifier basis). The common mode input range includes the negative supply, thereby eliminating the necessity for external biasing components in many applications. The output voltage range also includes the negative power supply voltage.

Features

- Short Circuit Protected Outputs
- True Differential Input Stage
- Single Supply Operation: 3.0 V to 32 V
- Low Input Bias Currents
- Internally Compensated
- Common Mode Range Extends to Negative Supply
- Single and Split Supply Operation
- ESD Clamps on the Inputs Increase Ruggedness of the Device without Affecting Operation
- NCV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant



ON Semiconductor®

www.onsemi.com



PDIP-8 N, AN, VN SUFFIX **CASE 626**

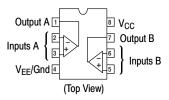


SOIC-8 D, VD SUFFIX **CASE 751**



Micro8™ **DMR2 SUFFIX** CASE 846A

PIN CONNECTIONS

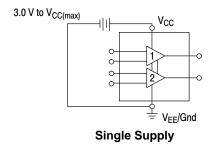


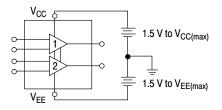
ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 10 of this data sheet.

DEVICE MARKING INFORMATION

See general marking information in the device marking section on page 11 of this data sheet.





Split Supplies

Figure 1.

·e 1

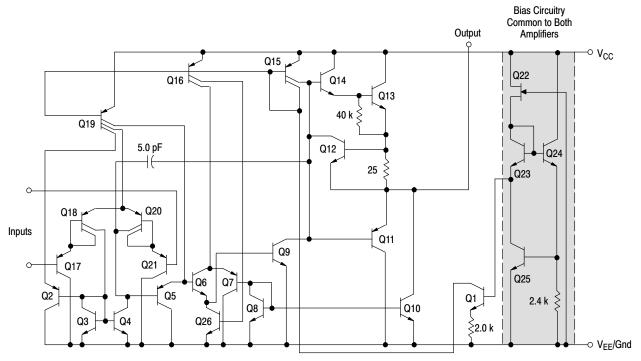


Figure 2. Representative Schematic Diagram (One–Half of Circuit Shown)

MAXIMUM RATINGS ($T_A = +25^{\circ}C$, unless otherwise noted.)

Rating	Symbol	Value	Unit
Power Supply Voltages Single Supply Split Supplies	V_{CC} V_{CC}, V_{EE}	32 ±16	Vdc
Input Differential Voltage Range (Note 1)	V_{IDR}	±32	Vdc
Input Common Mode Voltage Range	V _{ICR}	-0.3 to 32	Vdc
Output Short Circuit Duration	t _{SC}	Continuous	
Junction Temperature	T _J	150	°C
Thermal Resistance, Junction-to-Air (Note 2) Case 846A Case 751 Case 626	$R_{ hetaJA}$	238 212 161	°C/W
Storage Temperature Range	T _{stg}	-65 to +150	°C
ESD Protection at any Pin Human Body Model Machine Model	V _{esd}	2000 200	V
Operating Ambient Temperature Range LM258 LM358, LM358A LM2904/LM2904A LM2904V, NCV2904 (Note 3) NCV2904V (Note 3)	T _A	-25 to +85 0 to +70 -40 to +105 -40 to +125 -40 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

^{1.} Split Power Supplies.

All R_{θ,JA} measurements made on evaluation board with 1 oz. copper traces of minimum pad size. All device outputs were active.
 NCV2904 and NCV2904V are qualified for automotive use.

ELECTRICAL CHARACTERISTICS (V_{CC} = 5.0 V, V_{EE} = GND, T_A = 25°C, unless otherwise noted.)

		<u> </u>	LM258		<u> </u>	LM358		LM358A			
Characteristic	Symbol	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
Input Offset Voltage $\begin{array}{l} \text{V}_{CC} = 5.0 \text{ V to } 30 \text{ V, V}_{IC} = 0 \text{ V to V}_{CC} -1.7 \text{ V,} \\ \text{V}_{O} \simeq 1.4 \text{ V, R}_{S} = 0 \Omega \end{array}$	V _{IO}										mV
$T_A = 25^{\circ}C$		-	2.0	5.0	-	2.0	7.0	-	2.0	3.0	
$T_A = T_{high} \text{ (Note 4)}$		-	-	7.0	_	_	9.0	-	-	5.0	
$T_A = T_{low}$ (Note 4)		-	-	7.0	-	-	9.0	-	-	5.0	
Average Temperature Coefficient of Input Offset Voltage $T_A = T_{high}$ to T_{low} (Note 4)	$\Delta V_{IO}/\Delta T$	_	7.0	_	_	7.0	-	_	7.0	_	μV/°C
•			0.0	00		5 0	50		5 0	00	^
Input Offset Current $T_A = T_{high}$ to T_{low} (Note 4)	I _{IO}	_	3.0	30 100	_	5.0 –	50 150	_	5.0 –	30 75	nA
Input Bias Current	I _{IB}	_	- -45	-150	_	-45	-250	_	-45	-100	
$T_A = T_{high}$ to T_{low} (Note 4)	'IB	_	-50	-300	_	-50	-500	_	-50	-200	
Average Temperature Coefficient of Input Offset Current	$\Delta I_{IO}/\Delta T$	-	10	-	-	10	-	-	10	-	pA/°C
T _A = T _{high} to T _{low} (Note 4) Input Common Mode Voltage Range (Note 5),	V _{ICR}	0	_	28.3	0	_	28.3	0	_	28.5	V
$V_{CC} = 30 \text{ V}$ $V_{CC} = 30 \text{ V}, T_A = T_{high} \text{ to } T_{low}$		0	_	28	0	_	28	0	_	28	
Differential Input Voltage Range	V _{IDR}	_		V _{CC}	_	_	V _{CC}	_	_	V _{CC}	V
			_	v CC	_		v CC	_		v CC	
Large Signal Open Loop Voltage Gain	A_{VOL}	F0	100		25	100		25	100		V/mV
$R_L = 2.0 \text{ k}\Omega$, $V_{CC} = 15 \text{ V}$, For Large V_O Swing, $T_A = T_{high}$ to T_{low} (Note 4)		50 25	100	_	25 15	100	_	25 15	100	_	
	00		400		13	-	_	13	-		I.D.
Channel Separation 1.0 kHz \leq f \leq 20 kHz, Input Referenced	CS	_	-120	_	_	-120	-	_	-120	_	dB
Common Mode Rejection $R_{S} \leq 10 \ k\Omega$	CMR	70	85	-	65	70	-	65	70	-	dB
Power Supply Rejection	PSR	65	100	-	65	100	-	65	100	-	dB
Output Voltage–High Limit T _A = T _{high} to T _{low} (Note 4)	V _{OH}										V
$V_{CC} = 5.0 \text{ V}, R_L = 2.0 \text{ k}\Omega, T_A = 25^{\circ}\text{C}$		3.3	3.5	-	3.3	3.5	_	3.3	3.5	_	
V_{CC} = 30 V, R_L = 2.0 k Ω		26	-	-	26	_	-	26	-	_	
$V_{CC} = 30 \text{ V}, R_L = 10 \text{ k}\Omega$		27	28	-	27	28	-	27	28	-	
Output Voltage–Low Limit $V_{CC} = 5.0 \text{ V}, R_L = 10 \text{ k}\Omega, T_A = T_{high} \text{ to } T_{low} \text{ (Note 4)}$	V _{OL}	_	5.0	20	_	5.0	20	-	5.0	20	mV
Output Source Current	I _{O+}										mA
\dot{V}_{ID} = +1.0 V, \dot{V}_{CC} = 15 V T _A = T _{high} to T _{low} (LM358A Only)		20	40	-	20	40	-	20 10	40 -	_ _	
Output Sink Current	I _O –										
$V_{ID} = -1.0 \text{ V}, V_{CC} = 15 \text{ V}$	-0-	10	20	_	10	20	_	10	20	_	mA
$T_A = T_{high}$ to T_{low} (LM358A Only)								5.0	_	_	mA
$V_{ID} = -1.0 \text{ V}, V_{O} = 200 \text{ mV}$		12	50	_	12	50	-	12	50	_	μΑ
Output Short Circuit to Ground (Note 6)	I _{SC}	-	40	60	_	40	60	_	40	60	mA
Power Supply Current (Total Device) T _A = T _{high} to T _{low} (Note 4)	I _{CC}										mA
$V_{CC} = 30 \text{ V}, V_O = 0 \text{ V}, R_L = \infty$		_	1.5	3.0	_	1.5	3.0	_	1.5	2.0	
00 / O - / L	1	1	0.7	1.2		0.7	1.2		0.7	1.2	I

simultaneous shorts on all amplifiers.

ELECTRICAL CHARACTERISTICS (V_{CC} = 5.0 V, V_{EE} = Gnd, T_A = 25°C, unless otherwise noted.)

		LM2904		LM2904A			LM2904V, NCV2904 NCV2904V				
Characteristic	Symbol	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
Input Offset Voltage $ \begin{array}{l} V_{CC}=5.0 \text{ V to } 30 \text{ V, V}_{IC}=0 \text{ V to V}_{CC}-1.7 \text{ V,} \\ V_{O}=1.4 \text{ V, R}_{S}=0 \Omega \\ T_{A}=25^{\circ}\text{C} \\ T_{A}=T_{high} \text{ (Note 7)} \\ T_{A}=T_{low} \text{ (Note 7)} \end{array} $	V _{IO}		2.0	7.0 10 10	1 1 1	2.0	7.0 10 10		1 1 1	7.0 13 10	mV
Average Temperature Coefficient of Input Offset Voltage	$\Delta V_{IO}/\Delta T$	-	7.0	_	-	7.0	-	-	7.0	_	μV/°C
$T_A = T_{high}$ to T_{low} (Note 7)											
Input Offset Current $T_{A} = T_{high} \text{ to } T_{low} \text{ (Note 7)}$ Input Bias Current $T_{A} = T_{high} \text{ to } T_{low} \text{ (Note 7)}$	I _{IO}	- - -	5.0 45 -45 -50	50 200 -250 -500		5.0 45 -45 -50	50 200 –100 –250	- - -	5.0 45 -45 -50	50 200 -250 -500	nA
Average Temperature Coefficient of Input Offset Current $T_A = T_{high}$ to T_{low} (Note 7)	$\Delta I_{IO}/\Delta T$	-	10	_	-	10	-	-	10	-	pA/°C
Input Common Mode Voltage Range (Note 8), $V_{CC} = 30 \text{ V}$ $V_{CC} = 30 \text{ V}$, $T_A = T_{high}$ to T_{low}	V _{ICR}	0	-	28.3 28	0	-	28.3 28	0	1	28.3 28	V
Differential Input Voltage Range	V_{IDR}	_	-	V_{CC}	_	_	V _{CC}	_	_	V_{CC}	V
Large Signal Open Loop Voltage Gain $R_L = 2.0 \ k\Omega, \ V_{CC} = 15 \ V, \ For \ Large \ V_O \ Swing, \\ T_A = T_{high} \ to \ T_{low} \ (Note \ 7)$	A _{VOL}	25 15	100 –	- -	25 15	100 –	-	25 15	100	- -	V/mV
Channel Separation 1.0 kHz ≤ f ≤ 20 kHz, Input Referenced	CS	-	-120	_	-	-120	-	-	-120	_	dB
Common Mode Rejection $R_S \leq 10 \; k\Omega$	CMR	50	70	_	50	70	-	50	70	_	dB
Power Supply Rejection	PSR	50	100	-	50	100	-	50	100	-	dB
Output Voltage–High Limit $T_A = T_{high} \text{ to } T_{low} \text{ (Note 7)}$ $V_{CC} = 5.0 \text{ V, } R_L = 2.0 \text{ k}\Omega, T_A = 25^{\circ}\text{C}$ $V_{CC} = 30 \text{ V, } R_L = 2.0 \text{ k}\Omega$ $V_{CC} = 30 \text{ V, } R_L = 10 \text{ k}\Omega$	V _{OH}	3.3 26 27	3.5 - 28	- -	3.3 26 27	3.5 - 28	111	3.3 26 27	3.5 - 28	1 1 1	V
Output Voltage–Low Limit $V_{CC} = 5.0 \text{ V}, R_L = 10 \text{ k}\Omega, $ $T_A = T_{high} \text{ to } T_{low} \text{ (Note 7)}$	V _{OL}	-	5.0	20	_	5.0	20	-	5.0	20	mV
Output Source Current V _{ID} = +1.0 V, V _{CC} = 15 V	I _{O+}	20	40	-	20	40	-	20	40	_	mA
Output Sink Current $V_{ID} = -1.0 \text{ V}, V_{CC} = 15 \text{ V}$ $V_{ID} = -1.0 \text{ V}, V_O = 200 \text{ mV}$	I _{O -}	10 -	20 -	- -	10 -	20 -	-	10 -	20 -	- -	mA μA
Output Short Circuit to Ground (Note 9)	I _{SC}	-	40	60	-	40	60	-	40	60	mA
Power Supply Current (Total Device) $T_{A} = T_{high} \text{ to } T_{low} \text{ (Note 7)}$ $V_{CC} = 30 \text{ V, } V_{O} = 0 \text{ V, } R_{L} = \infty$ $V_{CC} = 5 \text{ V, } V_{O} = 0 \text{ V, } R_{L} = \infty$	I _{CC}	_ _	1.5 0.7	3.0 1.2	1 1	1.5 0.7	3.0 1.2	1 1	1.5 0.7	3.0 1.2	mA

^{7.} LM258: T_{low} = -25°C, T_{high} = +85°C

LM2904/LM2904A: T_{low} = -40°C, T_{high} = +105°C

NCV2904 and NCV2904V are qualified for automotive use.

NCV2904V: T_{low} = -40°C, T_{high} = +125°C

NCV2904V: T_{low} = -40°C, T_{high} = +150°C

8. The specified for automotive use is a signal voltage should not be allowed to go negative by more than 0.3 V. The upper end of the common mode voltage range is V_{CC} – 1.7 V.

9. Short circuits from the output to V_{CC} can cause excessive heating and eventual destruction. Destructive dissipation can result from

simultaneous shorts on all amplifiers.

CIRCUIT DESCRIPTION

The LM358 series is made using two internally compensated, two-stage operational amplifiers. The first stage of each consists of differential input devices Q20 and Q18 with input buffer transistors Q21 and Q17 and the differential to single ended converter Q3 and Q4. The first stage performs not only the first stage gain function but also performs the level shifting and transconductance reduction functions. By reducing the transconductance, a smaller compensation capacitor (only 5.0 pF) can be employed, thus saving chip area. The transconductance reduction is accomplished by splitting the collectors of Q20 and Q18. Another feature of this input stage is that the input common mode range can include the negative supply or ground, in single supply operation, without saturating either the input devices or the differential to single-ended converter. The second stage consists of a standard current source load amplifier stage.

Each amplifier is biased from an internal-voltage regulator which has a low temperature coefficient thus giving each amplifier good temperature characteristics as well as excellent power supply rejection.

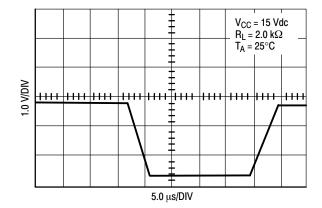


Figure 3. Large Signal Voltage Follower Response

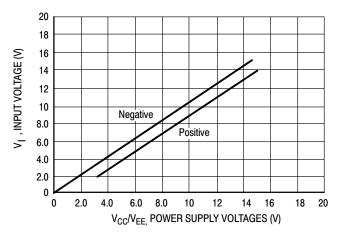


Figure 4. Input Voltage Range

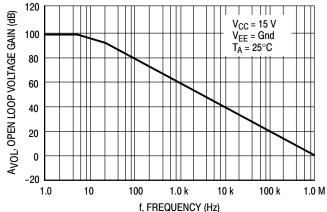


Figure 5. Large-Signal Open Loop Voltage Gain

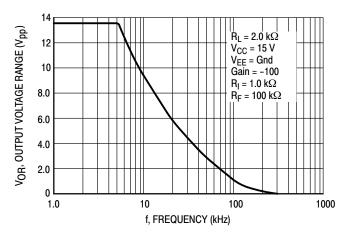


Figure 6. Large-Signal Frequency Response

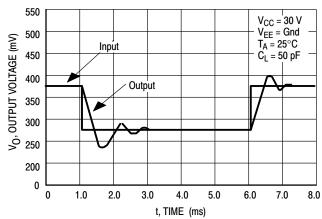


Figure 7. Small Signal Voltage Follower Pulse Response (Noninverting)

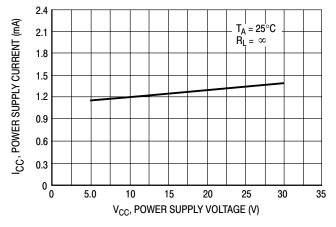


Figure 8. Power Supply Current versus Power Supply Voltage

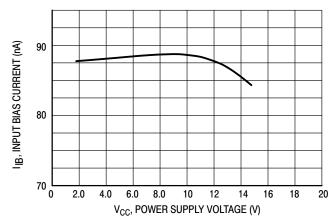


Figure 9. Input Bias Current versus Supply Voltage

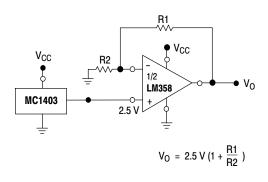


Figure 10. Voltage Reference

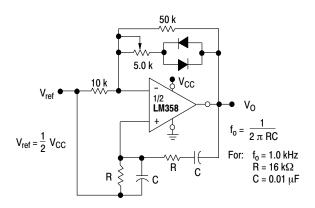


Figure 11. Wien Bridge Oscillator

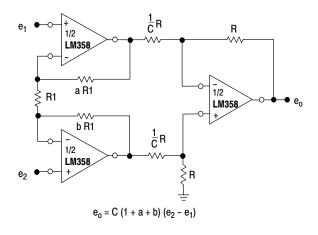


Figure 12. High Impedance Differential Amplifier

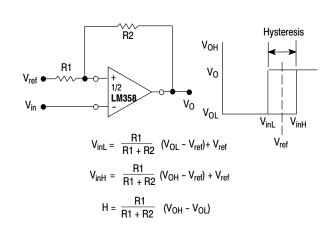


Figure 13. Comparator with Hysteresis

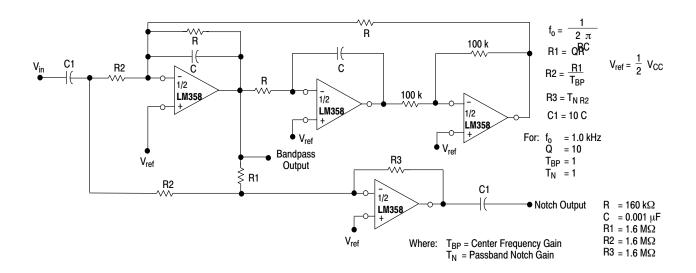
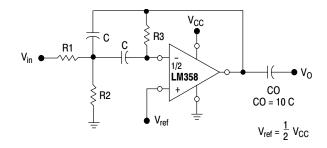


Figure 14. Bi-Quad Filter



Given: f_0 = center frequency $A(f_0)$ = gain at center frequency

Choose value fo, C

Then: R3 =
$$\frac{Q}{\pi f_0 C}$$

R1 = $\frac{R3}{2 A(f_0)}$
R2 = $\frac{R1 R3}{4Q^2 R1 - R3}$

For less than 10% error from operational amplifier. $\frac{Q_0 \, f_0}{BW} < 0.1$

Where fo and BW are expressed in Hz.

If source impedance varies, filter may be preceded with voltage follower buffer to stabilize filter parameters.

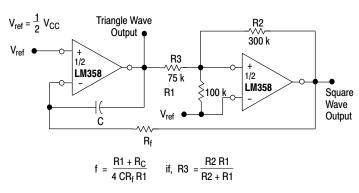


Figure 15. Function Generator

Figure 16. Multiple Feedback Bandpass Filter

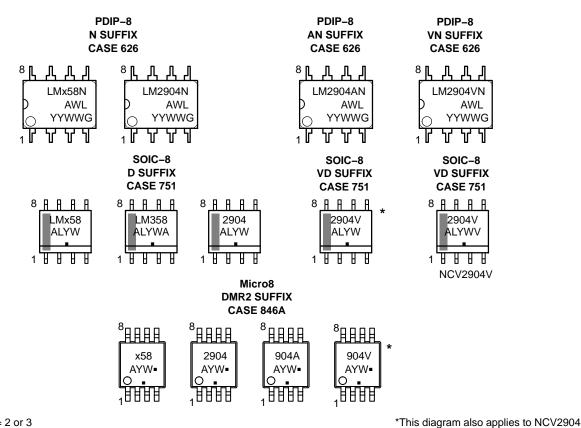
ORDERING INFORMATION

Device	Operating Temperature Range	Package	Shipping [†]
LM358ADR2G			2500 / Tape & Reel
LM358DG		SOIC-8 (Pb-Free)	98 Units / Rail
LM358DR2G		(15 1100)	2500 / Tape & Reel
LM358DMR2G	0°C to +70°C	Micro8 (Pb-Free)	4000 / Tape & Reel
LM358NG		PDIP-8 (Pb-Free)	50 Units / Rail
LM258DG		SOIC-8	98 Units / Rail
LM258DR2G		(Pb-Free)	2500 / Tape & Reel
LM258DMR2G	-25°C to +85°C	Micro8 (Pb-Free)	4000 / Tape & Reel
LM258NG		PDIP-8 (Pb-Free)	50 Units / Rail
LM2904DG		SOIC-8	98 Units / Rail
LM2904DR2G		(Pb-Free)	2500 / Tape & Reel
LM2904DMR2G		Micro8 (Pb-Free)	2500 / Tape & Reel
LM2904NG	−40°C to +105°C	PDIP-8 (Pb-Free)	50 Units / Rail
LM2904ADMG		Micro8 (Pb-Free)	4000 / Tape & Reel
LM2904ADMR2G			4000 / Tape & Reel
LM2904ANG		PDIP-8 (Pb-Free)	50 Units / Rail
LM2904VDG		SOIC-8	98 Units / Rail
LM2904VDR2G		(Pb-Free)	2500 / Tape & Reel
LM2904VDMR2G		Micro8 (Pb-Free)	4000 / Tape & Reel
LM2904VNG	-40°C to +125°C	PDIP-8 (Pb-Free)	50 Units / Rail
NCV2904DR2G*		SOIC-8 (Pb-Free)	2500 / Tape & Reel
NCV2904DMR2G*		Micro8 (Pb-Free)	4000 / Tape & Reel
NCV2904VDR2G*	-40°C to +150°C	SOIC-8 (Pb-Free)	2500 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.
*NCV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC–Q100 Qualified and PPAP

Capable.

MARKING DIAGRAMS



x = 2 or 3

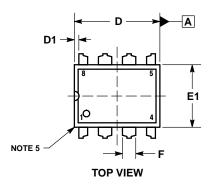
A = Assembly Location

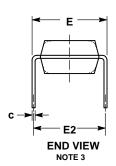
 $\begin{array}{ll} \text{WL, L} &= \text{Wafer Lot} \\ \text{YY, Y} &= \text{Year} \\ \text{WW, W} &= \text{Work Week} \\ \text{G} &= \text{Pb-Free Package} \end{array}$

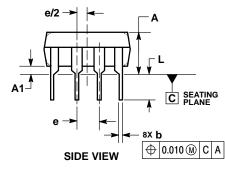
■ = Pb-Free Package – (Note: Microdot may be in either location)

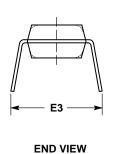
PACKAGE DIMENSIONS

PDIP-8 N, AN, VN SUFFIX CASE 626-05 ISSUE M







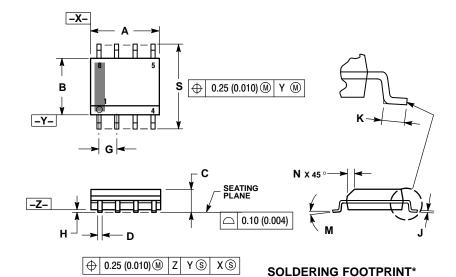


- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
 2. CONTROLLING DIMENSION: INCHES.
 3. DIMENSION E IS MEASURED WITH THE LEADS RESTRAINED PARALLEL AT WIDTH E2.
 4. DIMENSION E1 DOES NOT INCLUDE MOLD FLASH.
 5. ROUNDED CORNERS OPTIONAL.

	INCHES			MIL	RS	
DIM	MIN	NOM	MAX	MIN	MOM	MAX
Α			0.210			5.33
A1	0.015			0.38		
b	0.014	0.018	0.022	0.35	0.46	0.56
С	0.008	0.010	0.014	0.20	0.25	0.36
D	0.355	0.365	0.400	9.02	9.27	10.02
D1	0.005			0.13		
E	0.300	0.310	0.325	7.62	7.87	8.26
E1	0.240	0.250	0.280	6.10	6.35	7.11
E2	(0.300 BSC			7.62 BSC)
E3			0.430			10.92
е	0.100 BSC)	
L	0.115	0.130	0.150	2.92	3.30	3.81

PACKAGE DIMENSIONS

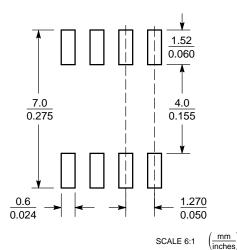
SOIC-8 NB CASE 751-07 **ISSUE AK**



NOTES:

- NOTES:
 1. DIMENSIONING AND TOLERANCING PER
 ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: MILLIMETER.
 3. DIMENSION A AND B DO NOT INCLUDE
 MOLD PROTRUSION.
 MAXIMUM DEPORTUSION A 45 (2006)
- MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
- 5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT
- MAXIMUM MATERIAL CONDITION.
 6. 751–01 THRU 751–06 ARE OBSOLETE. NEW STANDARD IS 751-07.

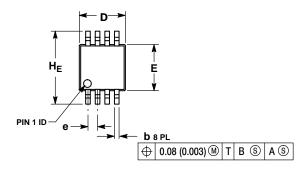
	MILLIN	IETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
Α	4.80	5.00	0.189	0.197
В	3.80	4.00	0.150	0.157
С	1.35	1.75	0.053	0.069
D	0.33	0.51	0.013	0.020
G	1.27	7 BSC	0.05	0 BSC
Н	0.10	0.25	0.004	0.010
J	0.19	0.25	0.007	0.010
K	0.40	1.27	0.016	0.050
М	0 °	8 °	0 °	8 °
N	0.25	0.50	0.010	0.020
S	5.80	6.20	0.228	0.244

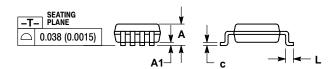


^{*}For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

PACKAGE DIMENSIONS

Micro8™ CASE 846A-02 **ISSUE H**



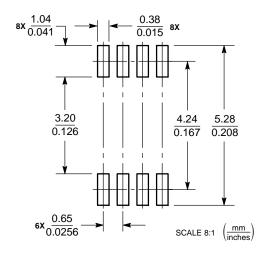


NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- CONTROLLING DIMENSION: MILLIMETER.
 DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH, PROTRUSIONS OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
- 0.13 (0.000) PER SIJE. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
- 846A-01 OBSOLETE, NEW STANDARD 846A-02.

	MILLIMETERS			INCHES				
DIM	MIN	NOM	MAX	MIN	NOM	MAX		
Α	-	-	1.10		-	0.043		
A1	0.05	0.08	0.15	0.002	0.003	0.006		
b	0.25	0.33	0.40	0.010	0.013	0.016		
С	0.13	0.18	0.23	0.005	0.007	0.009		
D	2.90	3.00	3.10	0.114	0.118	0.122		
E	2.90	3.00	3.10	0.114	0.118	0.122		
е		0.65 BSC		0.026 BSC				
L	0.40	0.55	0.70	0.016	0.021	0.028		
HE	4.75	4.90	5.05	0.187	0.193	0.199		

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

Micro8 is a trademark of International Rectifier.

are registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT

Literature Distribution Center for ON Semiconductor P.O. Box 5163, Denver, Colorado 80217 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada

Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com

N. American Technical Support: 800-282-9855 Toll Free USA/Canada

Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910

Japan Customer Focus Center Phone: 81–3–5817–1050

ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative